# MOSFET – Power, N-Channel, SUPERFET III, FRFET

# **650 V, 24 A, 150 m**Ω

### Description

SUPERFET III MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate.

Consequently, SUPERFET III MOSFET is very suitable for the various power system for miniaturization and higher efficiency.

SUPERFET III FRFET MOSFET's optimized reverse recovery performance of body diode can remove additional component and improve system reliability.

### Features

- 700 V @  $T_J = 150^{\circ}C$
- Typ. R<sub>DS(on)</sub> = 121 mΩ
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 43 nC)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 400 pF)
- 100% Avalanche Tested
- These Devices are Pb-Free and are RoHS Compliant

### Applications

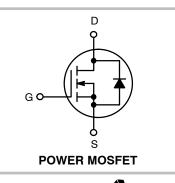
- Telecom / Server Power Supplies
- Industrial Power Supplies
- EV Charger
- UPS / Solar



# **ON Semiconductor®**

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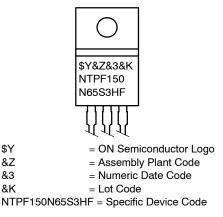
V <sub>DSS</sub>	V <sub>DSS</sub> R <sub>DS(ON)</sub> MAX I <sub>D</sub>	
650 V	150 mΩ @ 10 V	24 A





CASE 221D

#### **MARKING DIAGRAM**



### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit		
V <sub>DSS</sub>	Drain to Source Voltage	650	V		
V <sub>GSS</sub>	Gate to Source Voltage	– DC	±30	V	
		– AC (f > 1 Hz)	±30		
ID	Drain Current	– Continuous (T <sub>C</sub> = 25°C)	24*	А	
		– Continuous (T <sub>C</sub> = 100°C)	15.2*	7	
I <sub>DM</sub>	Drain Current	– Pulsed (Note 1)	60*	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		275	mJ	
I <sub>AS</sub>	Avalanche Current (Note 2)		3.8	А	
E <sub>AR</sub>	Repetitive Avalanche Energy (Note 1)		1.92	mJ	
dv/dt	MOSFET dv/dt		100	V/ns	
	Peak Diode Recovery dv/dt (Note 3)		50		
PD	Power Dissipation	(T <sub>C</sub> = 25°C)	192	W	
		– Derate Above 25°C	1.54	W/°C	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C	
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C	

### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. \*Drain current limited by maximum junction temperature.

1. Repetitive rating: pulse-width limited by maximum junction temperature. 2.  $I_{AS} = 3.8 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^{\circ}\text{C}$ . 3.  $I_{SD} \le 12 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, V_{DD} \le 400 \text{ V}, \text{ starting } T_J = 25^{\circ}\text{C}$ .

### **THERMAL CHARACTERISTICS**

Symbol	Parameter Value		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	3.22	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

### PACKAGE MARKING AND ORDERING INFORMATION

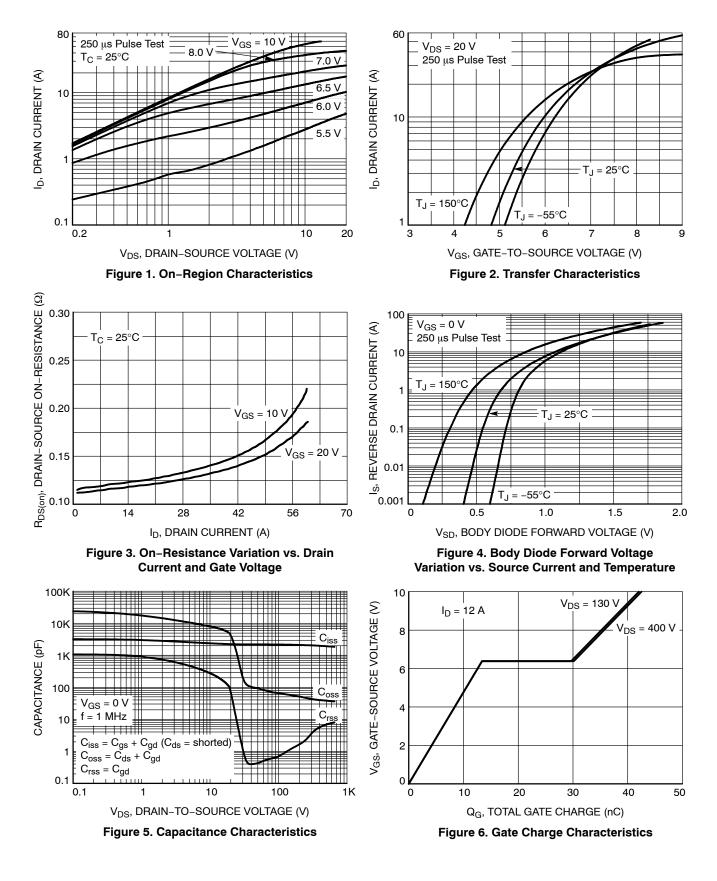
Part Number	Top Marking	Package	Packing Method	Reel Size	Tape Width	Quantity
NTPF150N65S3HF	NTPF150N65S3HF	TO-220 FULLPACK	Tube	N/A	N/A	50 Units

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

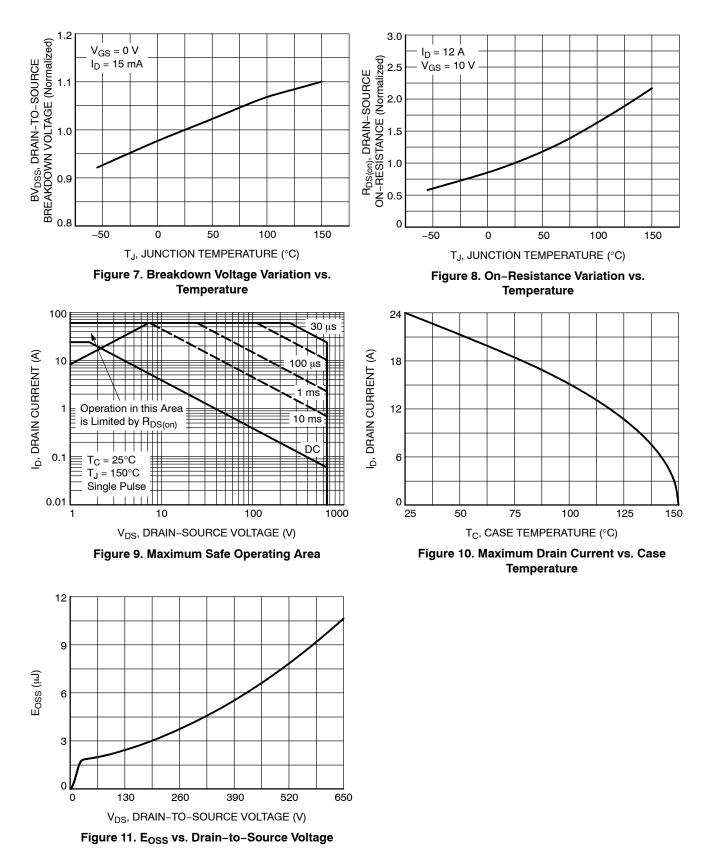
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS				•	
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 25°C	650			V
		$V_{GS}$ = 0 V, $I_D$ = 1 mA, $T_J$ = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}}  /  \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 15 \text{ mA}$ , Referenced to $25^{\circ}\text{C}$		0.62		V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS}$ = 650 V, $V_{GS}$ = 0 V			10	μΑ
		$V_{DS}$ = 520 V, $T_{C}$ = 125°C		67		
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±30 V, $V_{DS}$ = 0 V			±100	nA
ON CHARACTE	RISTICS					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 0.54$ mA	3.0		5.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12 A		121	150	mΩ
9fs	Forward Transconductance	$V_{DS} = 20 \text{ V}, \text{ I}_{D} = 12 \text{ A}$		14		S
DYNAMIC CHA	RACTERISTICS			•		
C <sub>iss</sub>	Input Capacitance			1985		pF
Coss	Output Capacitance	V <sub>DS</sub> = 400 V, V <sub>GS</sub> = 0 V, f = 1 MHz		40		pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V		400		pF
C <sub>oss(er.)</sub>	Energy Related Output Capacitance	$V_{DS}$ = 0 V to 400 V, $V_{GS}$ = 0 V	71			pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10 V			43		nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>DS</sub> = 400 V, I <sub>D</sub> = 12 A, V <sub>GS</sub> = 10 V (Note 4)		13		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			17		nC
ESR	Equivalent Series Resistance	f = 1 MHz		5.0		Ω
SWITCHING CH	IARACTERISTICS					
t <sub>d(on)</sub>	Turn-On Delay Time			21		ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ V}_{GS} = 10 \text{ V}$		19		ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$R_g = 4.7 \Omega$ (Note 4)		63		ns
t <sub>f</sub>	Turn-Off Fall Time			14		ns
SOURCE-DRAI	N DIODE CHARACTERISTICS			•	•	
I <sub>S</sub>	Maximum Continuous Source to Drain Diode Forward Current				24	А
I <sub>SM</sub>	Maximum Pulsed Source to Drain Diode Forward Current				60	А
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 12 A$			1.3	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>DD</sub> = 400 V, I <sub>SD</sub> = 12 A,		88		ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100 \text{ A}/\mu\text{s}$		306		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Essentially independent of operating temperature typical characteristics.

## **TYPICAL CHARACTERISTICS**



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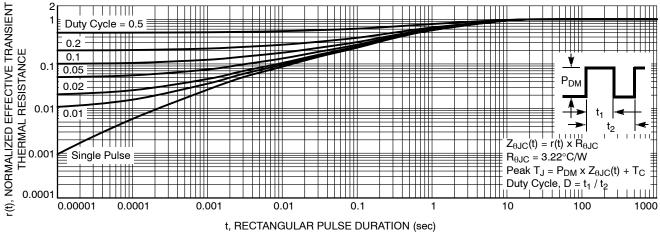
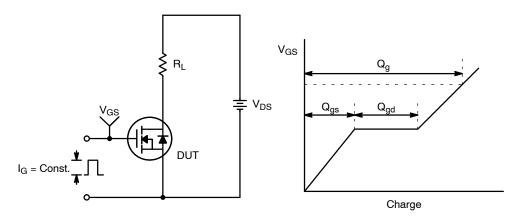


Figure 12. Transient Thermal Response Curve





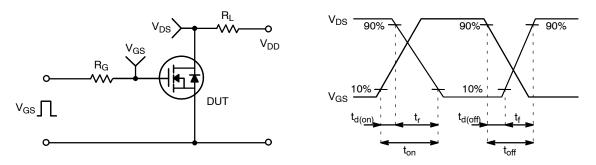
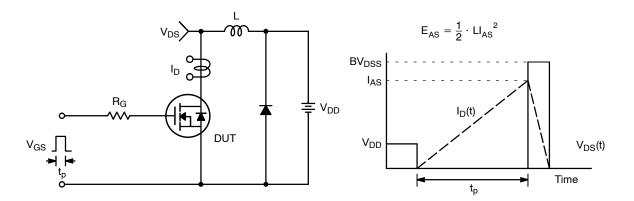


Figure 14. Resistive Switching Test Circuit & Waveforms





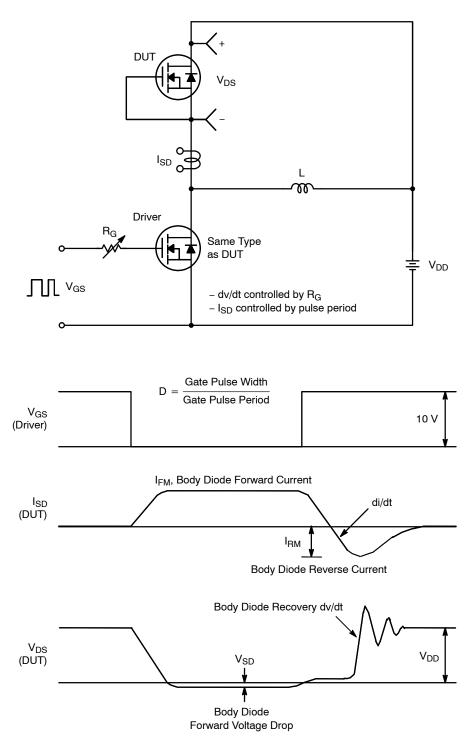
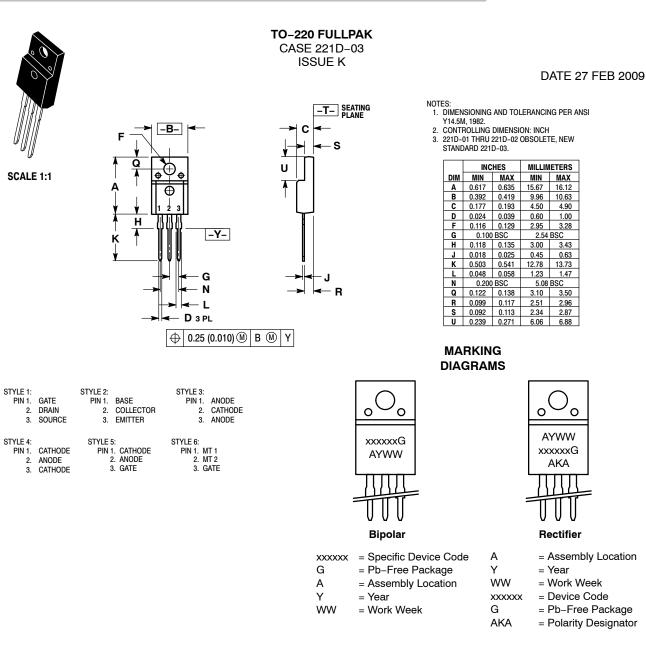


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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